

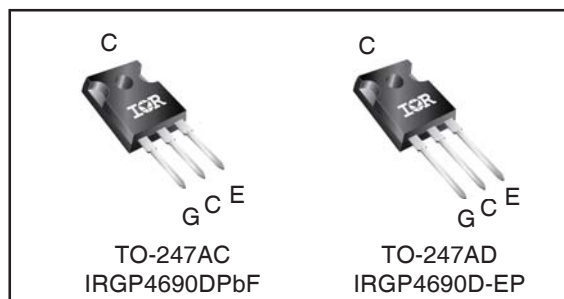
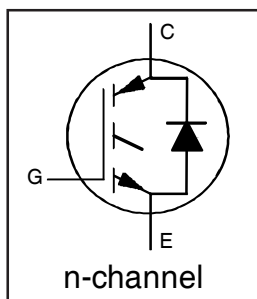
$$V_{CES} = 600V$$

$$I_C = 90A, T_C = 100^\circ C$$

$$t_{SC} \geq 5\mu s, T_{J(max)} = 175^\circ C$$

$$V_{CE(on)} \text{ typ.} = 1.70V @ I_C = 75A$$

### INSULATED GATE BIPOLAR TRANSISTOR WITH ULTRAFAST SOFT RECOVERY DIODE



#### Applications

- Industrial Motor Drive
- Inverters
- UPS
- Welding

| G    | C         | E       |
|------|-----------|---------|
| Gate | Collector | Emitter |

| Features                                            | Benefits                                                                                  |
|-----------------------------------------------------|-------------------------------------------------------------------------------------------|
| Low $V_{CE(ON)}$ and Switching Losses               | High efficiency in a wide range of applications and switching frequencies                 |
| Square RBSOA and Maximum Junction Temperature 175°C | Improved reliability due to rugged hard switching performance and higher power capability |
| Positive $V_{CE(ON)}$ Temperature Coefficient       | Excellent current sharing in parallel operation                                           |
| 5μs short circuit SOA                               | Enables short circuit protection scheme                                                   |
| Lead-Free, RoHS compliant                           | Environmentally friendly                                                                  |

| Base part number | Package Type | Standard Pack |          | Orderable part number |
|------------------|--------------|---------------|----------|-----------------------|
|                  |              | Form          | Quantity |                       |
| IRGP4690DPbF     | TO-247AC     | Tube          | 25       | IRGP4690DPbF          |
| IRGP4690D-EPbF   | TO-247AD     | Tube          | 25       | IRGP4690D-EPbF        |

#### Absolute Maximum Ratings

|                           | Parameter                                        | Max.                              | Units |
|---------------------------|--------------------------------------------------|-----------------------------------|-------|
| $V_{CES}$                 | Collector-to-Emitter Voltage                     | 600                               | V     |
| $I_C @ T_C = 25^\circ C$  | Continuous Collector Current                     | 140                               | A     |
| $I_C @ T_C = 100^\circ C$ | Continuous Collector Current                     | 90                                |       |
| $I_{CM}$                  | Pulse Collector Current, $V_{GE} = 15V$          | 225                               |       |
| $I_{LM}$                  | Clamped Inductive Load Current, $V_{GE} = 20V$ ① | 300                               |       |
| $I_F @ T_C = 25^\circ C$  | Diode Continuous Forward Current                 | 70                                |       |
| $I_F @ T_C = 100^\circ C$ | Diode Continuous Forward Current                 | 45                                |       |
| $I_{FM}$                  | Diode Maximum Forward Current ④                  | 300                               | V     |
| $V_{GE}$                  | Continuous Gate-to-Emitter Voltage               | ±20                               |       |
|                           | Transient Gate-to-Emitter Voltage                | ±30                               |       |
| $P_D @ T_C = 25^\circ C$  | Maximum Power Dissipation                        | 454                               | W     |
| $P_D @ T_C = 100^\circ C$ | Maximum Power Dissipation                        | 227                               |       |
| $T_J$                     | Operating Junction and                           | -55 to +175                       | °C    |
| $T_{STG}$                 | Storage Temperature Range                        |                                   |       |
|                           | Soldering Temperature, for 10 sec.               | 300 (0.063 in. (1.6mm) from case) |       |
|                           | Mounting Torque, 6-32 or M3 Screw                | 10 lbf-in (1.1 N·m)               |       |

#### Thermal Resistance

|                         | Parameter                                  | Min. | Typ. | Max. | Units |
|-------------------------|--------------------------------------------|------|------|------|-------|
| $R_{\theta JC}$ (IGBT)  | Junction-to-Case (IGBT) ②                  | —    | —    | 0.33 | °C/W  |
| $R_{\theta JC}$ (Diode) | Junction-to-Case (Diode) ②                 | —    | —    | 1.0  |       |
| $R_{\theta CS}$         | Case-to-Sink (flat, greased surface)       | —    | 0.24 | —    |       |
| $R_{\theta JA}$         | Junction-to-Ambient (typical socket mount) | —    | —    | 40   |       |

**Electrical Characteristics @  $T_J = 25^\circ\text{C}$  (unless otherwise specified)**

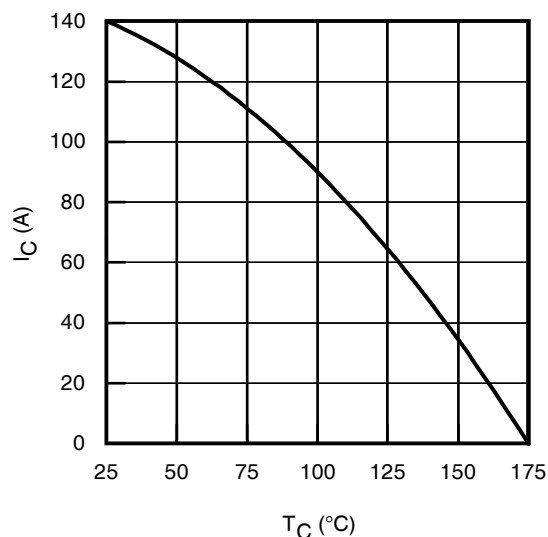
|                                 | Parameter                               | Min. | Typ. | Max.      | Units   | Conditions                                            |
|---------------------------------|-----------------------------------------|------|------|-----------|---------|-------------------------------------------------------|
| $V_{(BR)CES}$                   | Collector-to-Emitter Breakdown Voltage  | 600  | —    | —         | V       | $V_{GE} = 0V, I_C = 100\mu A$ ③                       |
| $\Delta V_{(BR)CES}/\Delta T_J$ | Temperature Coeff. of Breakdown Voltage | —    | 0.30 | —         | V/°C    | $V_{GE} = 0V, I_C = 2.0mA$ (25°C-175°C)               |
| $V_{CE(on)}$                    | Collector-to-Emitter Saturation Voltage | —    | 1.70 | 2.10      | V       | $I_C = 75A, V_{GE} = 15V, T_J = 25^\circ\text{C}$     |
|                                 |                                         | —    | 2.0  | —         |         | $I_C = 75A, V_{GE} = 15V, T_J = 150^\circ\text{C}$    |
|                                 |                                         | —    | 2.1  | —         |         | $I_C = 75A, V_{GE} = 15V, T_J = 175^\circ\text{C}$    |
| $V_{GE(th)}$                    | Gate Threshold Voltage                  | 4.0  | —    | 6.5       | V       | $V_{CE} = V_{GE}, I_C = 2.1mA$                        |
| $\Delta V_{GE(th)}/\Delta T_J$  | Threshold Voltage temp. coefficient     | —    | -21  | —         | mV/°C   | $V_{CE} = V_{GE}, I_C = 2.1mA$ (25°C - 175°C)         |
| $g_{fe}$                        | Forward Transconductance                | —    | 50   | —         | S       | $V_{CE} = 50V, I_C = 75A, PW = 60\mu s$               |
| $I_{CES}$                       | Collector-to-Emitter Leakage Current    | —    | 1.0  | 100       | $\mu A$ | $V_{GE} = 0V, V_{CE} = 600V$                          |
|                                 |                                         | —    | 1040 | —         |         | $V_{GE} = 0V, V_{CE} = 600V, T_J = 175^\circ\text{C}$ |
| $V_{FM}$                        | Diode Forward Voltage Drop              | —    | 2.23 | 3.0       | V       | $I_F = 75A$                                           |
|                                 |                                         | —    | 1.8  | —         |         | $I_F = 75A, T_J = 175^\circ\text{C}$                  |
| $I_{GES}$                       | Gate-to-Emitter Leakage Current         | —    | —    | $\pm 200$ | nA      | $V_{GE} = \pm 20V$                                    |

**Switching Characteristics @  $T_J = 25^\circ\text{C}$  (unless otherwise specified)**

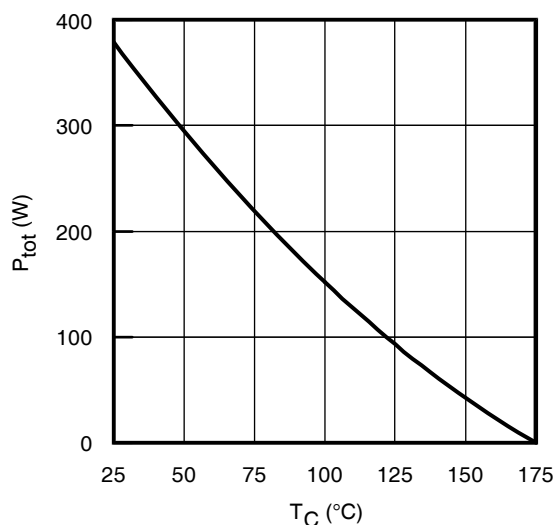
|              | Parameter                            | Min.        | Typ. | Max. | Units   | Conditions                                                                                                                                                   |
|--------------|--------------------------------------|-------------|------|------|---------|--------------------------------------------------------------------------------------------------------------------------------------------------------------|
| $Q_g$        | Total Gate Charge                    | —           | 150  | —    | nC      | $I_C = 75A$                                                                                                                                                  |
| $Q_{ge}$     | Gate-to-Emitter Charge               | —           | 40   | —    |         | $V_{GE} = 15V$                                                                                                                                               |
| $Q_{gc}$     | Gate-to-Collector Charge             | —           | 60   | —    |         | $V_{CC} = 400V$                                                                                                                                              |
| $E_{on}$     | Turn-On Switching Loss               | —           | 2465 | —    | $\mu J$ | $I_C = 75A, V_{CC} = 400V, V_{GE} = 15V$<br>$R_G = 10\Omega, L = 200\mu H, T_J = 25^\circ\text{C}$<br>Energy losses include tail & diode reverse recovery ⑤  |
| $E_{off}$    | Turn-Off Switching Loss              | —           | 2155 | —    |         |                                                                                                                                                              |
| $E_{total}$  | Total Switching Loss                 | —           | 4620 | —    |         |                                                                                                                                                              |
| $t_{d(on)}$  | Turn-On delay time                   | —           | 50   | —    | ns      |                                                                                                                                                              |
| $t_r$        | Rise time                            | —           | 70   | —    |         |                                                                                                                                                              |
| $t_{d(off)}$ | Turn-Off delay time                  | —           | 200  | —    |         |                                                                                                                                                              |
| $t_f$        | Fall time                            | —           | 60   | —    |         |                                                                                                                                                              |
| $E_{on}$     | Turn-On Switching Loss               | —           | 3870 | —    | $\mu J$ | $I_C = 75A, V_{CC} = 400V, V_{GE} = 15V$<br>$R_G = 10\Omega, L = 200\mu H, T_J = 175^\circ\text{C}$<br>Energy losses include tail & diode reverse recovery ⑤ |
| $E_{off}$    | Turn-Off Switching Loss              | —           | 2815 | —    |         |                                                                                                                                                              |
| $E_{total}$  | Total Switching Loss                 | —           | 6685 | —    |         |                                                                                                                                                              |
| $t_{d(on)}$  | Turn-On delay time                   | —           | 50   | —    | ns      |                                                                                                                                                              |
| $t_r$        | Rise time                            | —           | 70   | —    |         |                                                                                                                                                              |
| $t_{d(off)}$ | Turn-Off delay time                  | —           | 240  | —    |         |                                                                                                                                                              |
| $t_f$        | Fall time                            | —           | 70   | —    |         |                                                                                                                                                              |
| $C_{ies}$    | Input Capacitance                    | —           | 4440 | —    | pF      | $V_{GE} = 0V$<br>$V_{CC} = 30V$<br>$f = 1.0MHz$                                                                                                              |
| $C_{oes}$    | Output Capacitance                   | —           | 245  | —    |         |                                                                                                                                                              |
| $C_{res}$    | Reverse Transfer Capacitance         | —           | 130  | —    |         |                                                                                                                                                              |
| RBSOA        | Reverse Bias Safe Operating Area     | FULL SQUARE |      |      |         | $T_J = 175^\circ\text{C}, I_C = 300A$<br>$V_{CC} = 480V, V_p \leq 600V$<br>$R_G = 10\Omega, V_{GE} = +20V$ to 0V                                             |
| SCSOA        | Short Circuit Safe Operating Area    | 5           | —    | —    | $\mu s$ | $V_{CC} = 400V, V_p \leq 600V$<br>$R_G = 10\Omega, V_{GE} = +15V$ to 0V                                                                                      |
| $E_{rec}$    | Reverse Recovery Energy of the Diode | —           | 470  | —    | $\mu J$ | $T_J = 175^\circ\text{C}$                                                                                                                                    |
| $t_{rr}$     | Diode Reverse Recovery Time          | —           | 155  | —    | ns      | $V_{CC} = 400V, I_F = 75A$                                                                                                                                   |
| $I_{rr}$     | Peak Reverse Recovery Current        | —           | 27   | —    | A       | $V_{GE} = 15V, R_G = 10\Omega, L = 60\mu H$                                                                                                                  |

**Notes:**

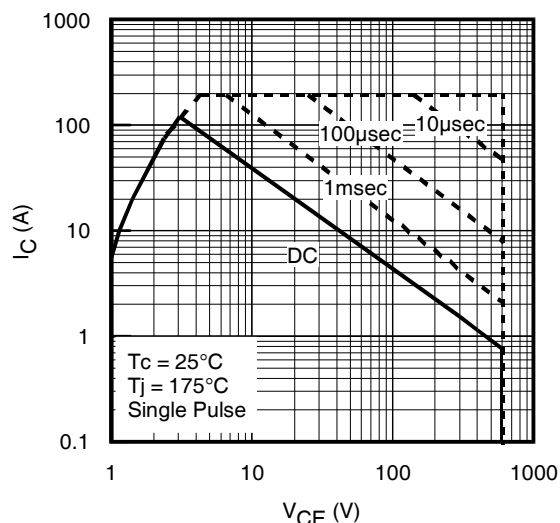
- ①  $V_{CC} = 80\% (V_{CES}), V_{GE} = 20V, L = 10\mu H, R_G = 10\Omega$ .
- ②  $R_{\theta}$  is measured at  $T_J$  of approximately 90°C.
- ③ Refer to AN-1086 for guidelines for measuring  $V_{(BR)CES}$  safely.
- ④ Pulse width limited by max. junction temperature.
- ⑤ Values influenced by parasitic L and C in measurement.



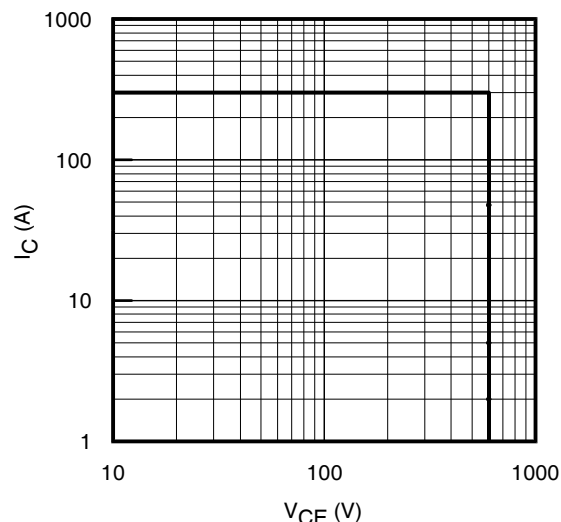
**Fig. 1** - Maximum DC Collector Current vs. Case Temperature



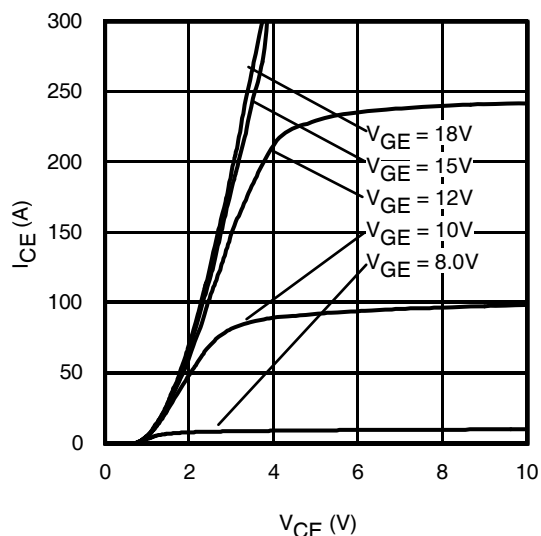
**Fig. 2** - Power Dissipation vs. Case Temperature



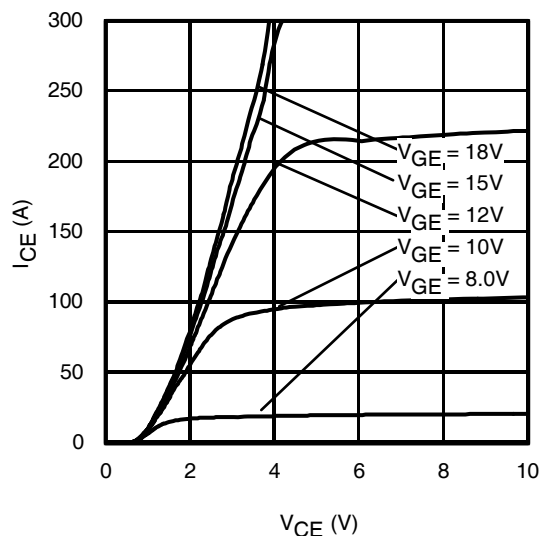
**Fig. 3** - Forward SOA  
 $T_C = 25^\circ\text{C}$ ,  $T_J \leq 175^\circ\text{C}$ ;  $V_{GE} = 15\text{V}$



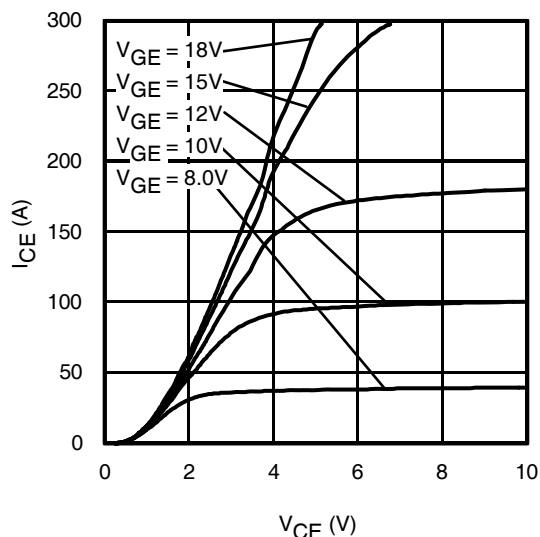
**Fig. 4** - Reverse Bias SOA  
 $T_J = 175^\circ\text{C}$ ;  $V_{GE} = 20\text{V}$



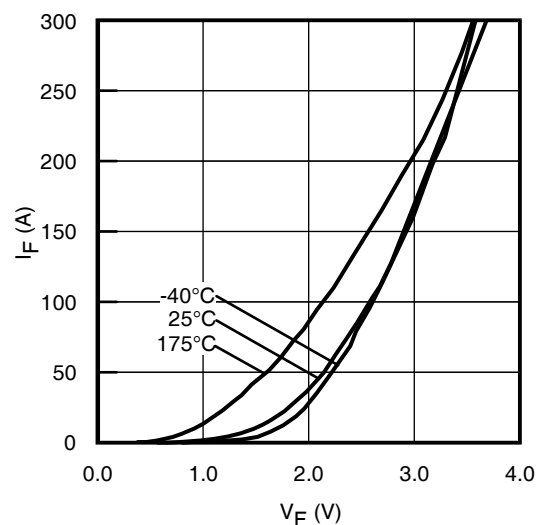
**Fig. 5** - Typ. IGBT Output Characteristics  
 $T_J = -40^\circ\text{C}$ ;  $t_p \leq 60\mu\text{s}$



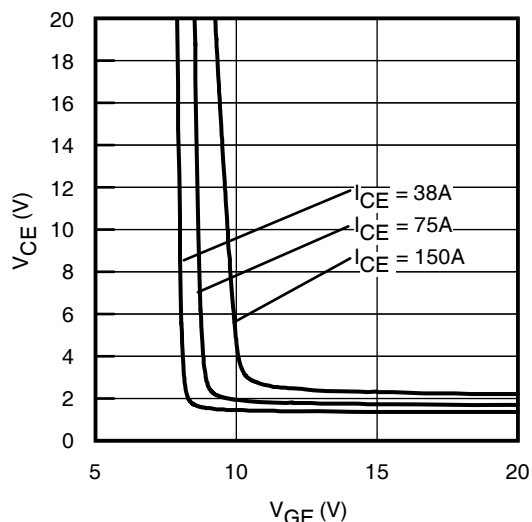
**Fig. 6** - Typ. IGBT Output Characteristics  
 $T_J = 25^\circ\text{C}$ ;  $t_p \leq 60\mu\text{s}$



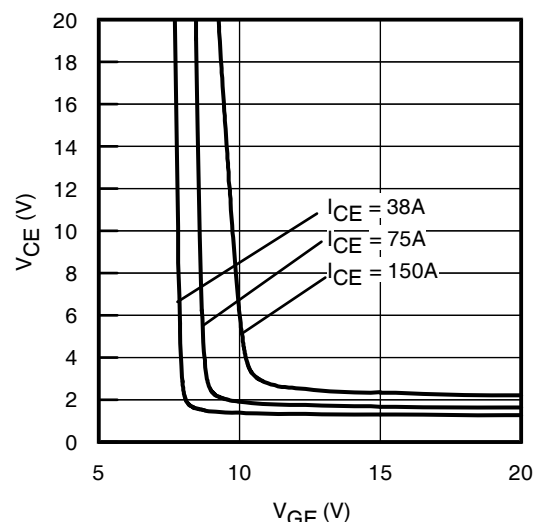
**Fig. 7 - Typ. IGBT Output Characteristics**  
 $T_J = 175^\circ\text{C}$ ;  $t_p \leq 60\mu\text{s}$



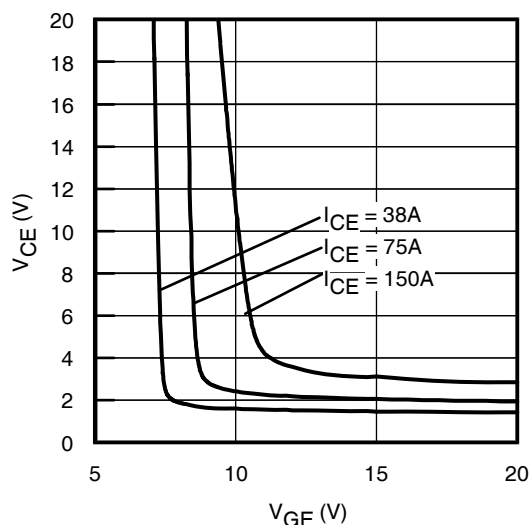
**Fig. 8 - Typ. Diode Forward Characteristics**  
 $t_p = 80\mu\text{s}$



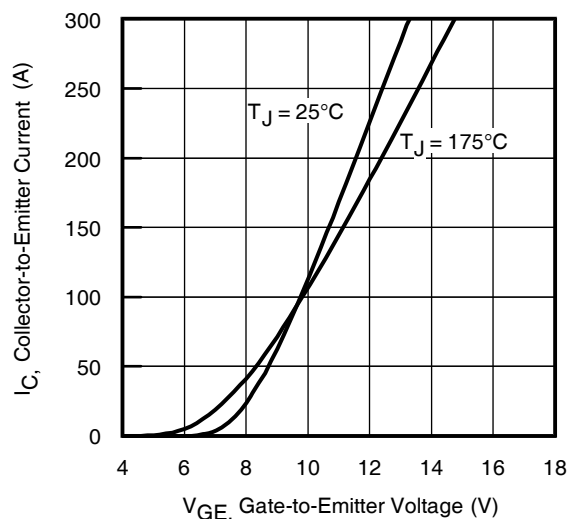
**Fig. 9 - Typical  $V_{CE}$  vs.  $V_{GE}$**   
 $T_J = -40^\circ\text{C}$



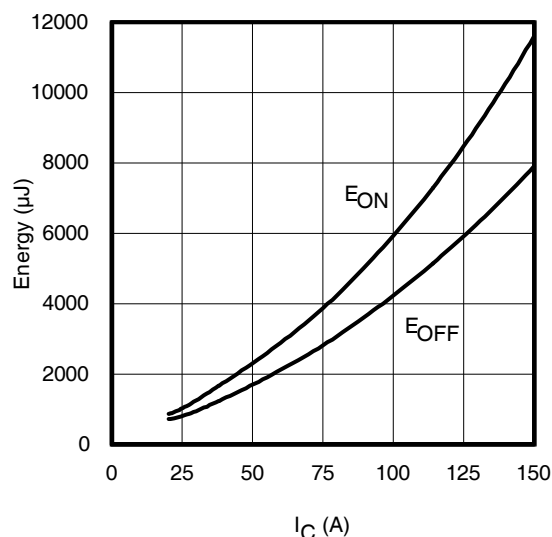
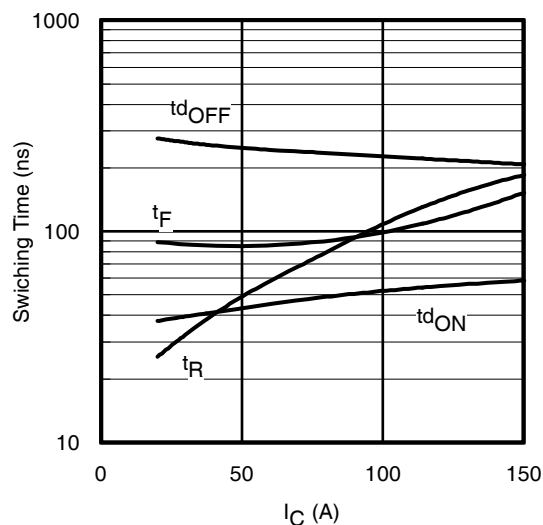
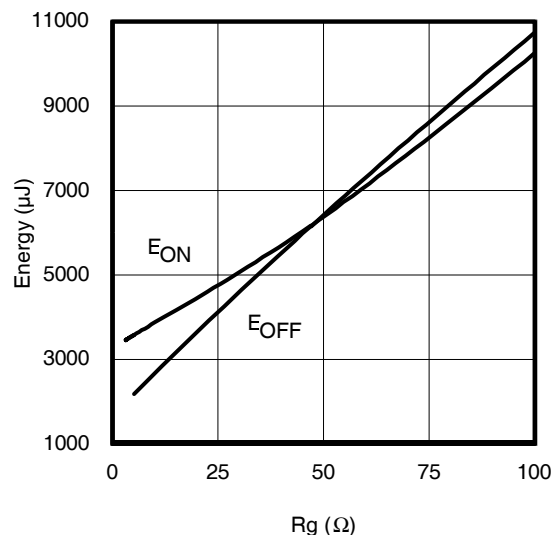
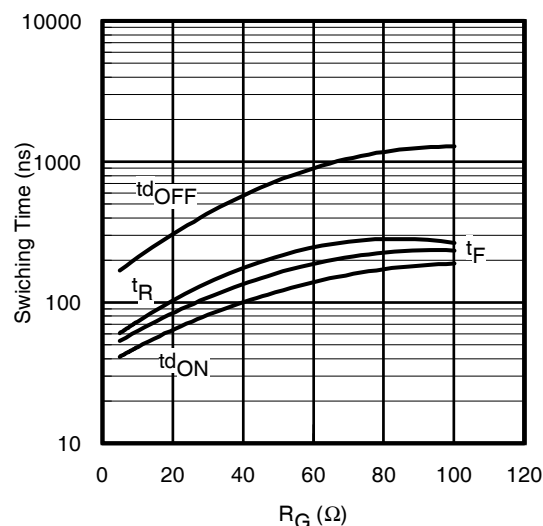
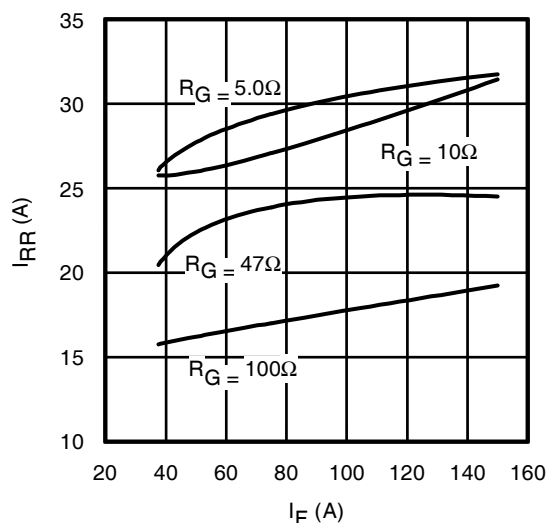
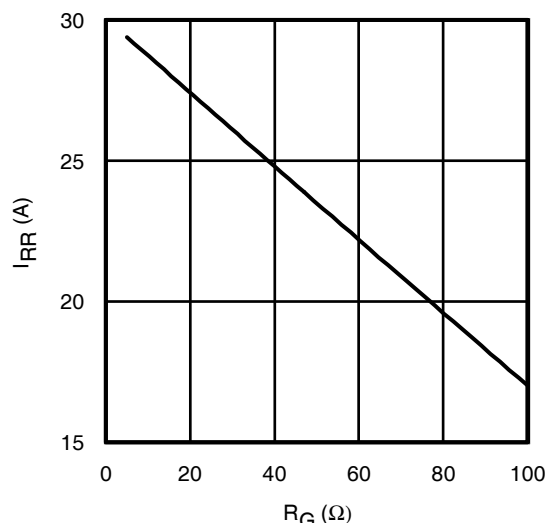
**Fig. 10 - Typical  $V_{CE}$  vs.  $V_{GE}$**   
 $T_J = 25^\circ\text{C}$

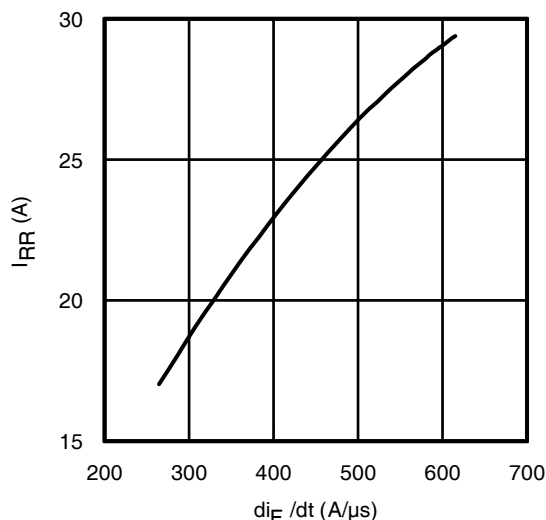


**Fig. 11 - Typical  $V_{CE}$  vs.  $V_{GE}$**   
 $T_J = 175^\circ\text{C}$

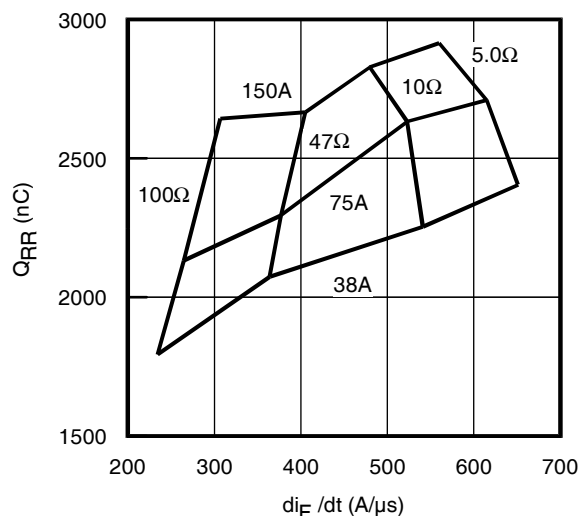


**Fig. 12 - Typ. Transfer Characteristics**  
 $V_{CE} = 50\text{V}$ ;  $t_p = 60\mu\text{s}$

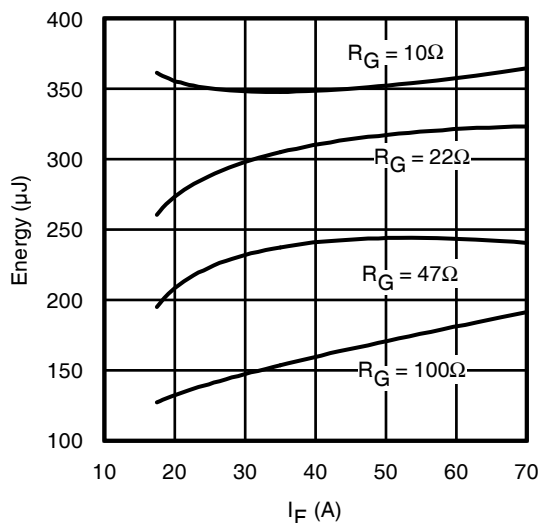

**Fig. 13 - Typ. Energy Loss vs.  $I_C$** 
 $T_J = 175^\circ\text{C}$ ;  $L = 200\mu\text{H}$ ;  $V_{CE} = 400\text{V}$ ;  $R_G = 10\Omega$ ;  $V_{GE} = 15\text{V}$ 

**Fig. 14 - Typ. Switching Time vs.  $I_C$** 
 $T_J = 175^\circ\text{C}$ ;  $L = 200\mu\text{H}$ ;  $V_{CE} = 400\text{V}$ ;  $R_G = 10\Omega$ ;  $V_{GE} = 15\text{V}$ 

**Fig. 15 - Typ. Energy Loss vs.  $R_G$** 
 $T_J = 175^\circ\text{C}$ ;  $L = 200\mu\text{H}$ ;  $V_{CE} = 400\text{V}$ ;  $I_{CE} = 75\text{A}$ ;  $V_{GE} = 15\text{V}$ 

**Fig. 16 - Typ. Switching Time vs.  $R_G$** 
 $T_J = 175^\circ\text{C}$ ;  $L = 200\mu\text{H}$ ;  $V_{CE} = 400\text{V}$ ;  $I_{CE} = 75\text{A}$ ;  $V_{GE} = 15\text{V}$ 

**Fig. 17 - Typ. Diode  $I_{RR}$  vs.  $I_F$**   
 $T_J = 175^\circ\text{C}$ 

**Fig. 18 - Typ. Diode  $I_{RR}$  vs.  $R_G$**   
 $T_J = 175^\circ\text{C}$



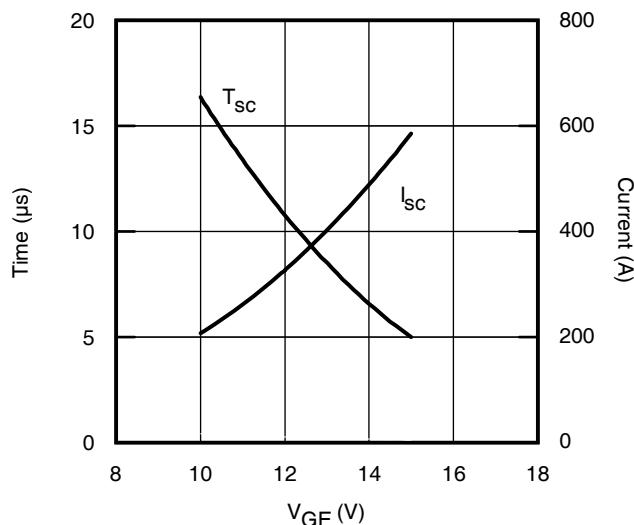
**Fig. 19** - Typ. Diode  $I_{RR}$  vs.  $di_F/dt$   
 $V_{CC} = 400V$ ;  $V_{GE} = 15V$ ;  $I_F = 75A$ ;  $T_J = 175^\circ C$



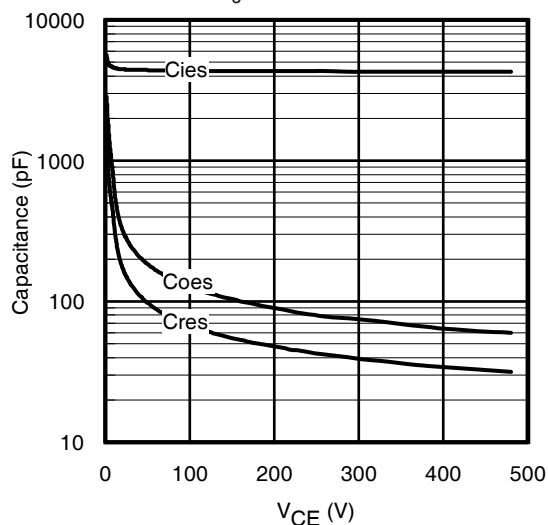
**Fig. 20** - Typ. Diode  $Q_{RR}$  vs.  $di_F/dt$   
 $V_{CC} = 400V$ ;  $V_{GE} = 15V$ ;  $T_J = 175^\circ C$



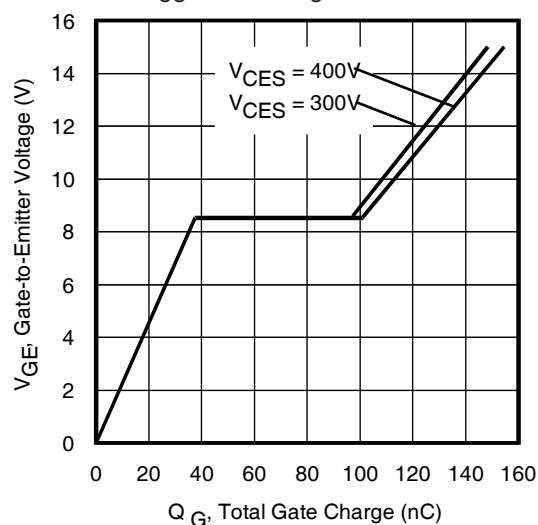
**Fig. 21** - Typ. Diode  $E_{RR}$  vs.  $I_F$   
 $T_J = 175^\circ C$



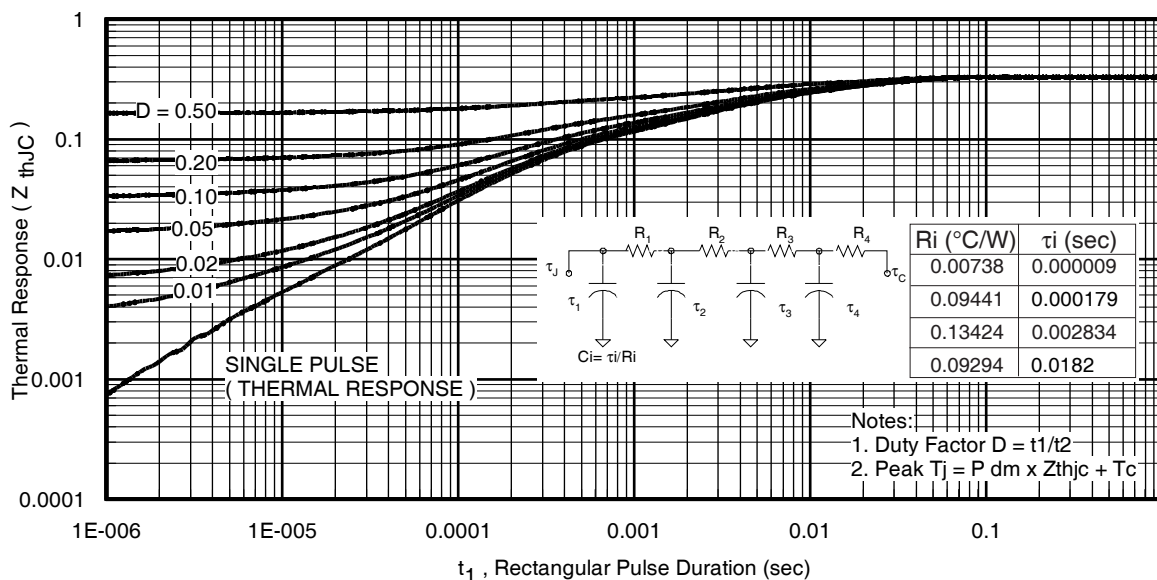
**Fig. 22** -  $V_{GE}$  vs. Short Circuit Time  
 $V_{CC} = 400V$ ;  $T_C = 25^\circ C$



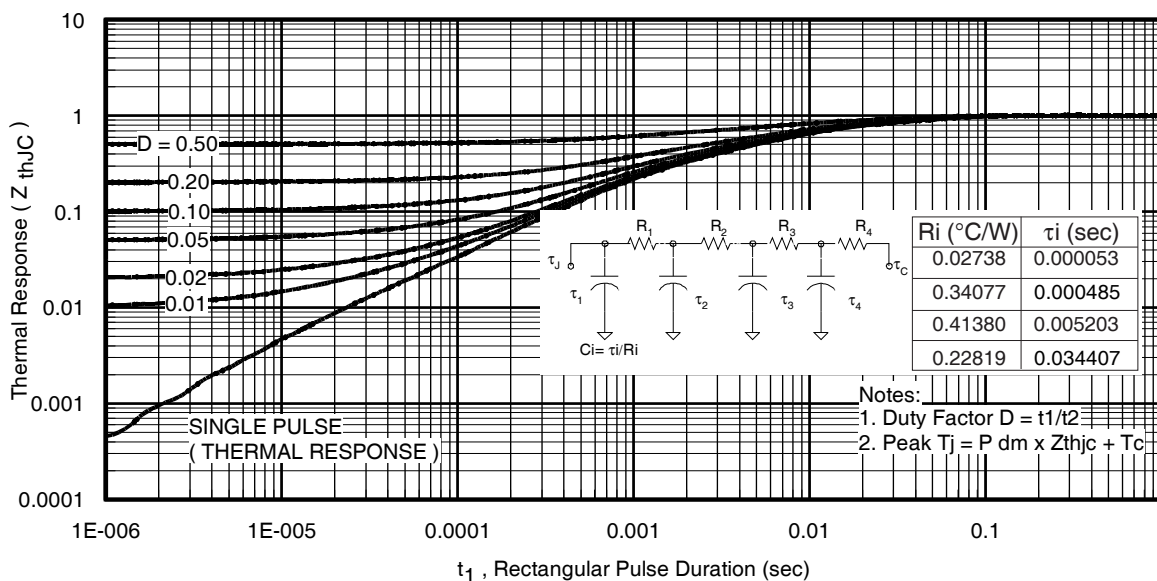
**Fig. 23** - Typ. Capacitance vs.  $V_{CE}$   
 $V_{GE} = 0V$ ;  $f = 1MHz$



**Fig. 24** - Typical Gate Charge vs.  $V_{GE}$   
 $I_{CE} = 75A$ ;  $L = 485\mu H$



**Fig 25.** Maximum Transient Thermal Impedance, Junction-to-Case (IGBT)



**Fig. 26.** Maximum Transient Thermal Impedance, Junction-to-Case (DIODE)

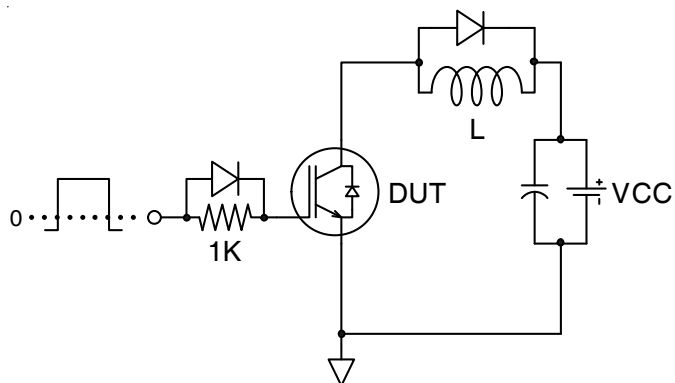


Fig.C.T.1 - Gate Charge Circuit (turn-off)

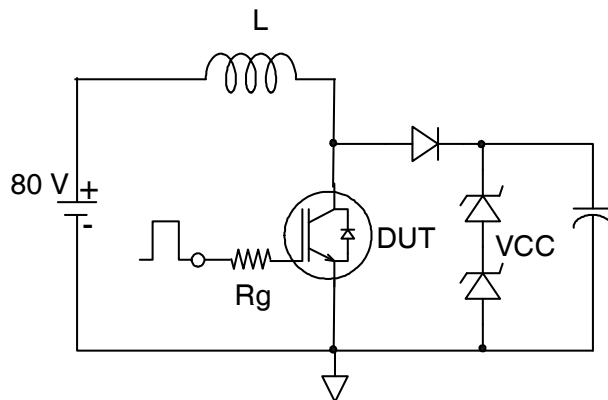


Fig.C.T.2 - RBSOA Circuit

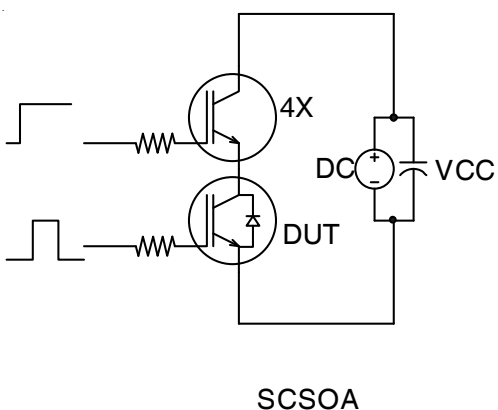


Fig.C.T.3 - S.C. SOA Circuit

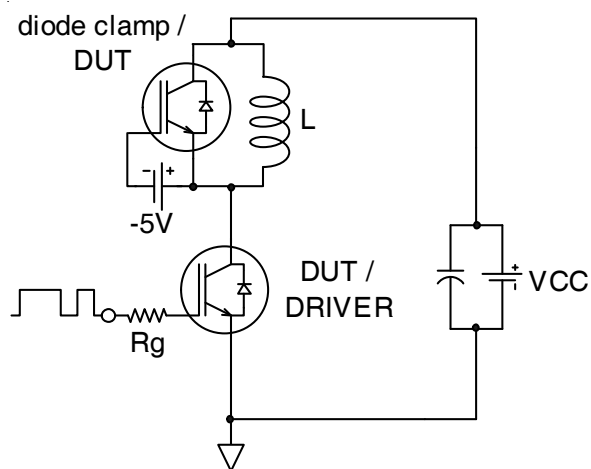


Fig.C.T.4 - Switching Loss Circuit

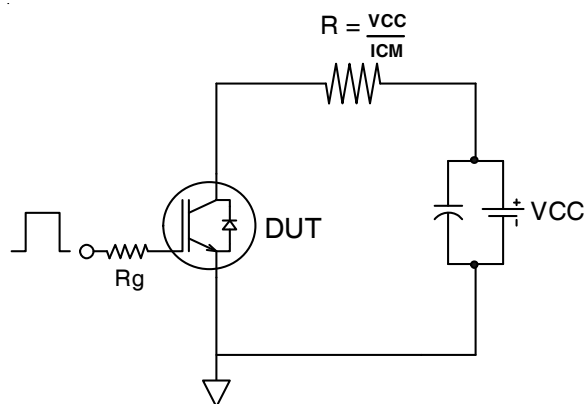


Fig.C.T.5 - Resistive Load Circuit

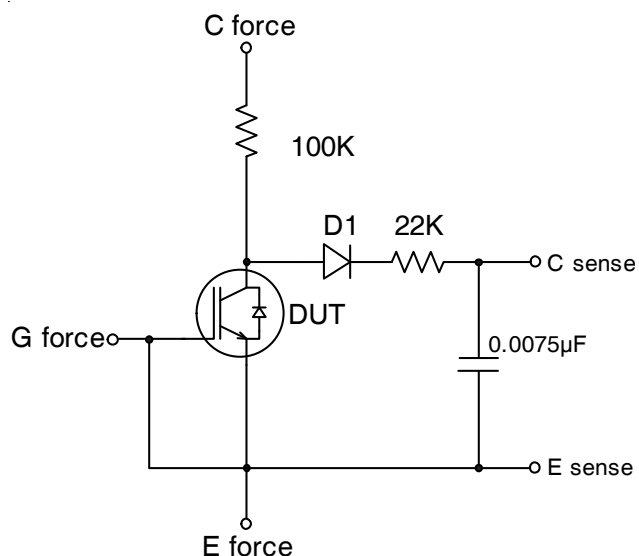
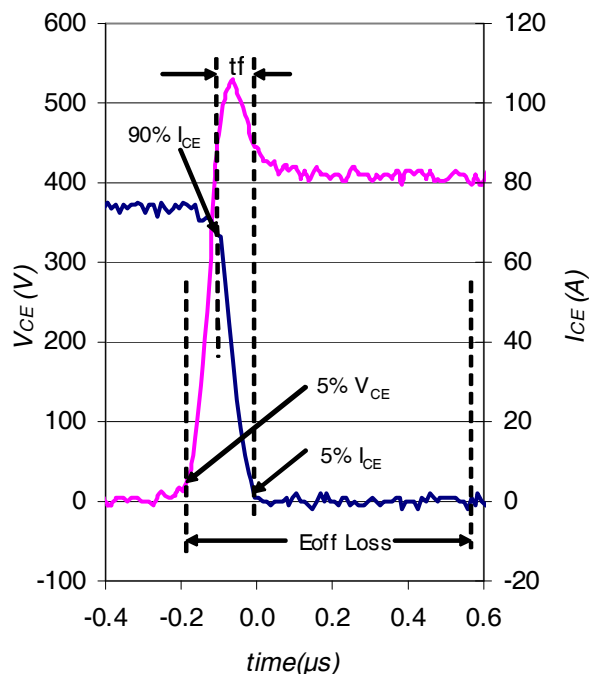
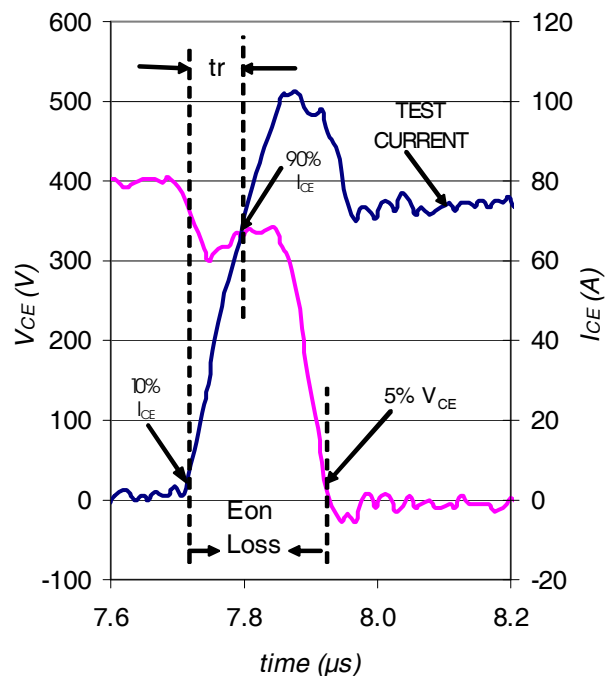


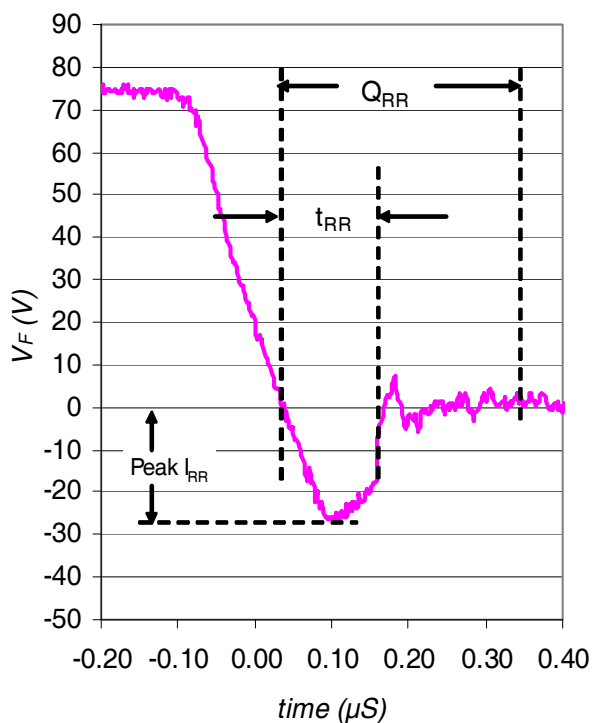
Fig.C.T.6 - BVCES Filter Circuit



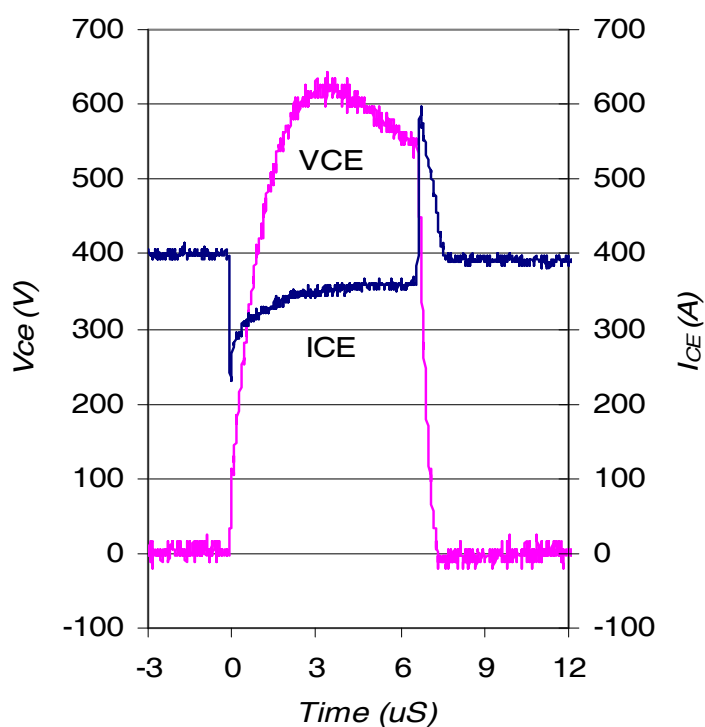
**Fig. WF1** - Typ. Turn-off Loss Waveform  
@  $T_J = 175^\circ\text{C}$  using Fig. CT.4



**Fig. WF2** - Typ. Turn-on Loss Waveform  
@  $T_J = 175^\circ\text{C}$  using Fig. CT.4



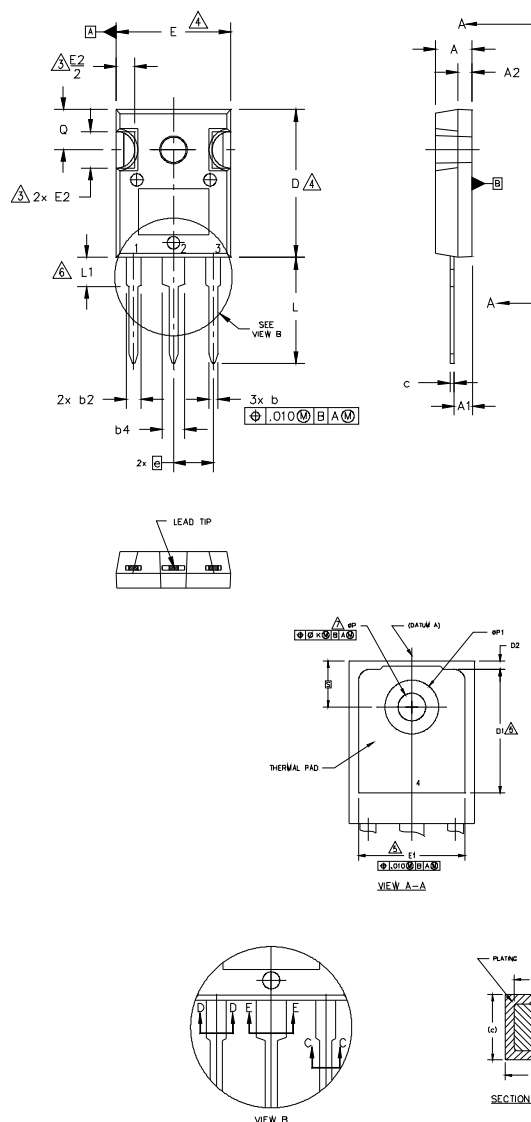
**Fig. WF3** - Typ. Diode Recovery Waveform  
@  $T_J = 175^\circ\text{C}$  using Fig. CT.4



**Fig. WF4** - Typ. S.C. Waveform  
@  $T_J = 25^\circ\text{C}$  using Fig. CT.3

## TO-247AC Package Outline

Dimensions are shown in millimeters (inches)



### NOTES:

1. DIMENSIONING AND TOLERANCING AS PER ASME Y14.5M 1994.
2. DIMENSIONS ARE SHOWN IN INCHES.
3. CONTOUR OF SLOT OPTIONAL.
4. DIMENSION D & E DO NOT INCLUDE MOLD FLASH. MOLD FLASH SHALL NOT EXCEED .005" (0.127) PER SIDE. THESE DIMENSIONS ARE MEASURED AT THE OUTERMOST EXTREMES OF THE PLASTIC BODY.
5. THERMAL PAD CONTOUR OPTIONAL WITHIN DIMENSIONS D1 & E1.
6. LEAD FINISH UNCONTROLLED IN L1.
7.  $\phi P$  TO HAVE A MAXIMUM DRAFT ANGLE OF 1.5° TO THE TOP OF THE PART WITH A MAXIMUM HOLE DIAMETER OF .154 INCH.
8. OUTLINE CONFORMS TO JEDEC OUTLINE TO-247AC.

| SYMBOL | DIMENSIONS |      |             |       | NOTES |
|--------|------------|------|-------------|-------|-------|
|        | INCHES     |      | MILLIMETERS |       |       |
|        | MIN.       | MAX. | MIN.        | MAX.  |       |
| A      | .183       | .209 | 4.65        | 5.31  |       |
| A1     | .087       | .102 | 2.21        | 2.59  |       |
| A2     | .059       | .098 | 1.50        | 2.49  |       |
| b      | .039       | .055 | 0.99        | 1.40  |       |
| b1     | .039       | .053 | 0.99        | 1.35  |       |
| b2     | .065       | .094 | 1.65        | 2.39  |       |
| b3     | .065       | .092 | 1.65        | 2.34  |       |
| b4     | .102       | .135 | 2.59        | 3.43  |       |
| b5     | .102       | .133 | 2.59        | 3.38  |       |
| c      | .015       | .035 | 0.38        | 0.89  |       |
| c1     | .015       | .033 | 0.38        | 0.84  |       |
| D      | .776       | .815 | 19.71       | 20.70 | 4     |
| D1     | .515       | —    | 13.08       | —     | 5     |
| D2     | .020       | .053 | 0.51        | 1.35  |       |
| E      | .602       | .625 | 15.29       | 15.87 | 4     |
| E1     | .530       | —    | 13.46       | —     |       |
| E2     | .178       | .216 | 4.52        | 5.49  |       |
| e      | .215 BSC   |      | 5.46 BSC    |       |       |
| Øk     | .010       |      | 0.25        |       |       |
| L      | .559       | .634 | 14.20       | 16.10 |       |
| L1     | .146       | .169 | 3.71        | 4.29  |       |
| ØP     | .140       | .144 | 3.56        | 3.66  |       |
| ØP1    | —          | .291 | —           | 7.39  |       |
| Q      | .209       | .224 | 5.31        | 5.69  |       |
| S      | .217 BSC   |      | 5.51 BSC    |       |       |

### LEAD ASSIGNMENTS

#### HEXFET

- 1.- GATE
- 2.- DRAIN
- 3.- SOURCE
- 4.- DRAIN

#### IGBTs, CoPACK

- 1.- GATE
- 2.- COLLECTOR
- 3.- EMITTER
- 4.- COLLECTOR

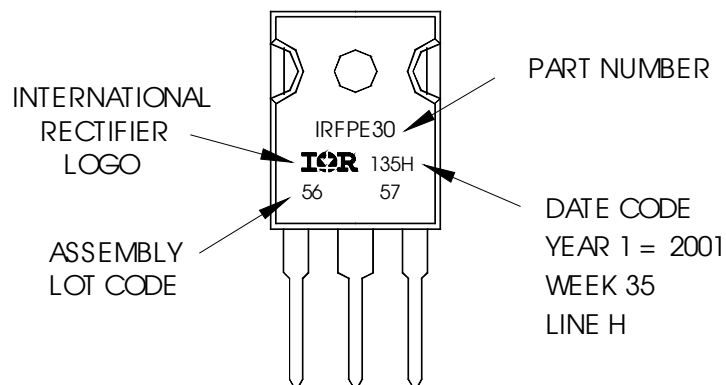
#### DIODES

- 1.- ANODE/OPEN
- 2.- CATHODE
- 3.- ANODE

## TO-247AC Part Marking Information

EXAMPLE: THIS IS AN IRFPE30  
WITH ASSEMBLY  
LOT CODE 5657  
ASSEMBLED ON WW 35, 2001  
IN THE ASSEMBLY LINE "H"

Note: "P" in assembly line position  
indicates "Lead-Free"

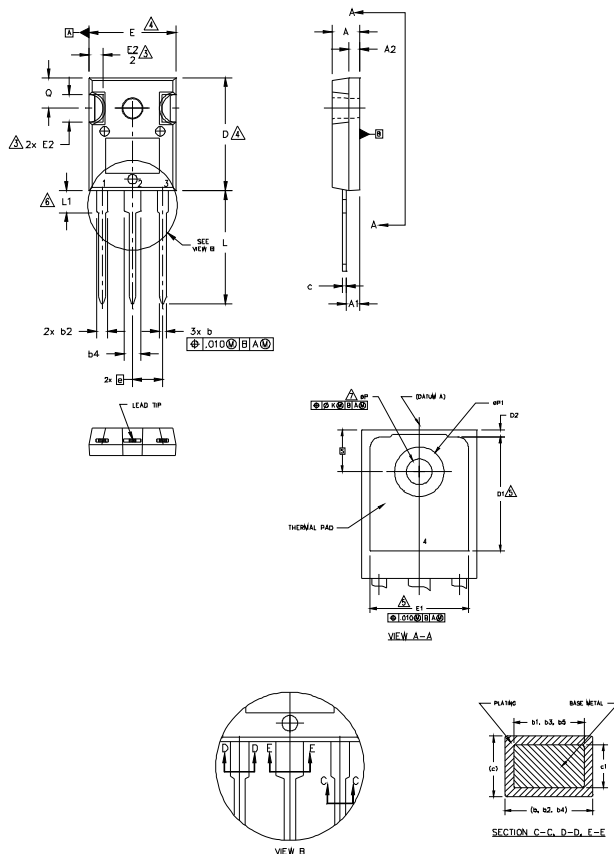


TO-247AC package is not recommended for Surface Mount Application.

Note: For the most current drawing please refer to IR website at <http://www.irf.com/package/>

## TO-247AD Package Outline

Dimensions are shown in millimeters (inches)



### NOTES:

1. DIMENSIONING AND TOLERANCING AS PER ASME Y14.5M 1994.
2. DIMENSIONS ARE SHOWN IN INCHES.  
CONTOUR OF SLOT OPTIONAL.
3. DIMENSION D & E DO NOT INCLUDE MOLD FLASH. MOLD FLASH SHALL NOT EXCEED .005" (0.127) PER SIDE. THESE DIMENSIONS ARE MEASURED AT THE OUTERMOST EXTREMES OF THE PLASTIC BODY.
4. THERMAL PAD CONTOUR OPTIONAL WITHIN DIMENSIONS D1 & E1.
5. LEAD FINISH UNCONTROLLED IN L1.
6. ØP TO HAVE A MAXIMUM DRAFT ANGLE OF 1.5 ° TO THE TOP OF THE PART WITH A MAXIMUM HOLE DIAMETER OF .154 INCH.
7. OUTLINE CONFORMS TO JEDEC OUTLINE TO-247AD.

| SYMBOL | DIMENSIONS |      |             |       | NOTES |
|--------|------------|------|-------------|-------|-------|
|        | INCHES     |      | MILLIMETERS |       |       |
|        | MIN.       | MAX. | MIN.        | MAX.  |       |
| A      | .183       | .209 | 4.65        | 5.31  |       |
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| b      | .039       | .055 | 0.99        | 1.40  |       |
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| b2     | .065       | .094 | 1.65        | 2.39  |       |
| b3     | .065       | .092 | 1.65        | 2.34  |       |
| b4     | .102       | .135 | 2.59        | 3.43  |       |
| b5     | .102       | .133 | 2.59        | 3.38  |       |
| c      | .015       | .035 | 0.38        | 0.89  |       |
| c1     | .015       | .033 | 0.38        | 0.84  |       |
| D      | .776       | .815 | 19.71       | 20.70 | 4     |
| D1     | .515       | -    | 13.08       | -     | 5     |
| D2     | .020       | .053 | 0.51        | 1.35  |       |
| E      | .602       | .625 | 15.29       | 15.87 | 4     |
| E1     | .530       | -    | 13.46       | -     |       |
| E2     | .178       | .216 | 4.52        | 5.49  |       |
| e      | .215 BSC   |      | 5.46 BSC    |       |       |
| Øk     | .010       |      | 0.25        |       |       |
| L      | .780       | .827 | 19.57       | 21.00 |       |
| L1     | .146       | .169 | 3.71        | 4.29  |       |
| ØP     | .140       | .144 | 3.56        | 3.66  |       |
| ØP1    | -          | .291 | -           | 7.39  |       |
| Q      | .209       | .224 | 5.31        | 5.69  |       |
| S      | .217 BSC   |      | 5.51 BSC    |       |       |

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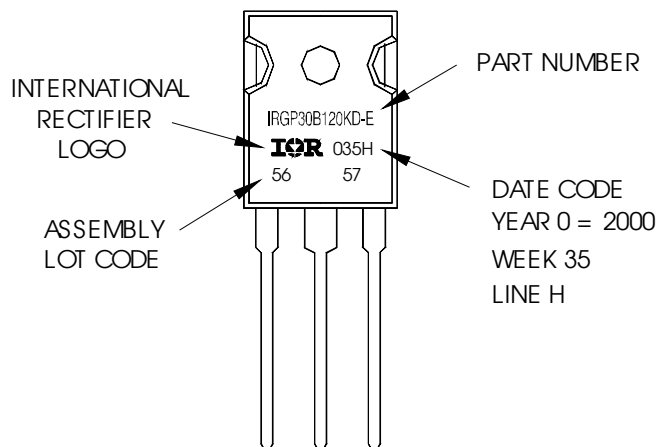
#### DIODES

- 1.- ANODE/OPEN
- 2.- CATHODE
- 3.- ANODE

## TO-247AD Part Marking Information

EXAMPLE: THIS IS AN IRGP30B120KD-E  
WITH ASSEMBLY  
LOT CODE 5657  
ASSEMBLED ON WW 35, 2000  
IN THE ASSEMBLY LINE "H"

Note: "P" in assembly line position  
indicates "Lead-Free"



TO-247AD package is not recommended for Surface Mount Application.

Note: For the most current drawing please refer to IR website at <http://www.irf.com/package/>

### Qualification Information<sup>†</sup>

|                                   |                      |                                                                   |     |
|-----------------------------------|----------------------|-------------------------------------------------------------------|-----|
| <b>Qualification Level</b>        |                      | Industrial<br>(per International Rectifier's internal guidelines) |     |
| <b>Moisture Sensitivity Level</b> |                      | TO-247AC                                                          | N/A |
|                                   |                      | TO-247AD                                                          | N/A |
| <b>ESD</b>                        | Human Body Model     | Class 3A (+/- 4000V) <sup>††</sup><br>(per JEDEC JESD22-A114)     |     |
|                                   | Charged Device Model | Class C5 (+/- 1125V) <sup>††</sup><br>(per JEDEC JESD22-C101)     |     |
| <b>RoHS Compliant</b>             |                      | Yes                                                               |     |

<sup>†</sup> Qualification standards can be found at International Rectifier's web site: <http://www.irf.com/product-info/reliability>

<sup>††</sup> Highest passing voltage.

### Revision History

| Date       | Comments                                                                                                                                                                                      |
|------------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 11/14/2014 | <ul style="list-style-type: none"> <li>Added note ④ to I<sub>FM</sub> Diode Maximum Forward Current on page 1.</li> <li>Added note ⑤ to switching losses test condition on page 2.</li> </ul> |